

Figure 18. Schematic Diagram, Sheet 1 of 2

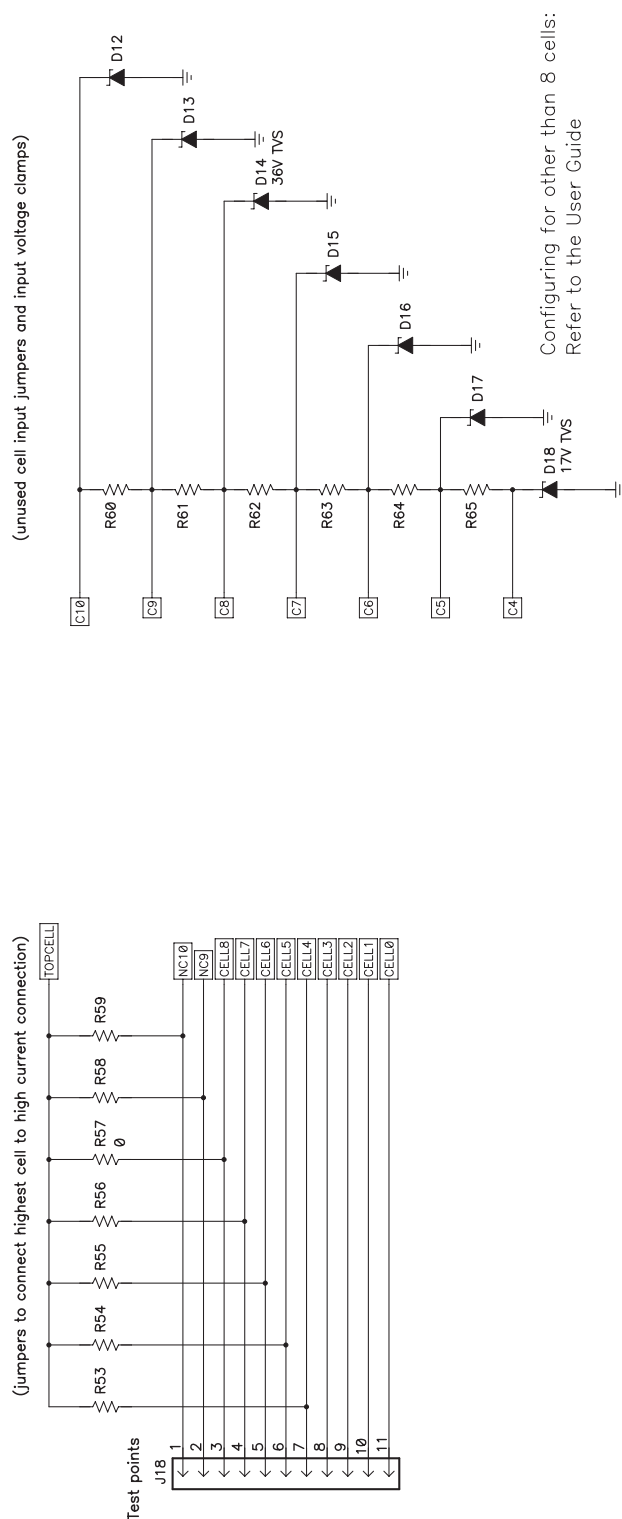


Figure 19. Schematic Diagram, Sheet 2 of 2

8.1.3 bq77908A Circuit Module Performance Specification Summary

This section summarizes the performance specifications of the bq77908A circuit module in its default 8-cell parallel FET configuration.

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